

#### **Features**

- UL recognition, file #E230084
- Glass passivated chip junction
- Thin single in-line package
- High surge current capability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

# **Typical Applications**

General purpose use in AC/DC bridge full wave rectification for switching power supply, home appliances, office equipment, industrial automation applications.

### **Mechanical Data**

Package: 4KBJ
 Molding compound meets LII

Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant

• **Terminals**: Tin plated leads, solderable per J-STD-002 and JESD22-B102

• Polarity: As marked on body

## ■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	KBJ1016	
Device marking code				KBJ1016	
Maximum Repetitive Peak Reverse Voltage		VRRM	V	1600	
Maximum RMS Voltage		VRMS	V	1120	
Maximum DC blocking Voltage		VDC	V	1600	
Average Rectified Output Current @60Hz sine wave, R-load	With heatsink Tc =110°C	- IO	А	10.0	
	Without heatsink Ta =25℃			3.6	
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25°C		IFSM	А	160	
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C				320	
Current squared time @1ms≤t≤8.3ms Tj=25°C,rating of per diode		l <sup>2</sup> t	A <sup>2</sup> S	106	
Storage temperature		Tstg	°C	-55 ~ +150	
Junction temperature		Tj	°C	-55 ~ +150	
Dielectric strength @ Terminals to case, AC 1 minute		Vdis	KV	2	
Mounting torque @Recommend torque: 5kg·cm		Tor	kg⋅cm	8	

### ■Electrical Characteristics (Ta=25°C Unless otherwise specified)

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PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	KBJ1016				
Maximum instantaneous forward voltage drop per diode	VF	٧	IFM=5.0A	1.05				
Maximum DC reverse current at rated DC blocking voltage	IR	μΑ	T <sub>j</sub> =25°C	5				
per diode			T <sub>j</sub> =125°C	100				
Typical junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	40				



# ■Thermal Characteristics (Ta=25°C Unless otherwise specified)

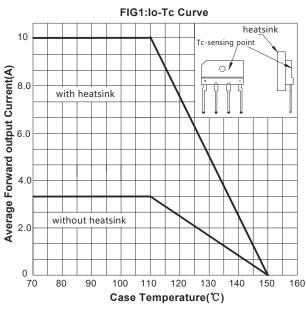
PARAMETER		SYMBOL	UNIT	KBJ1016
Thermal	Between junction and ambient, Without heatsink	R <sub>0</sub> J-A	°C/W	20
Resistance	Between junction and case, With heatsink	R <sub>0</sub> J-C		2

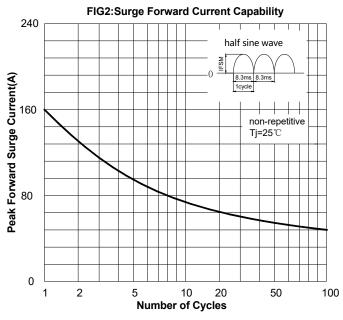
Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

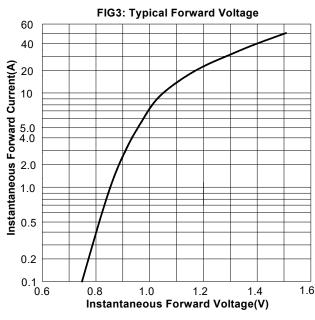
**■Ordering Information** (Example)

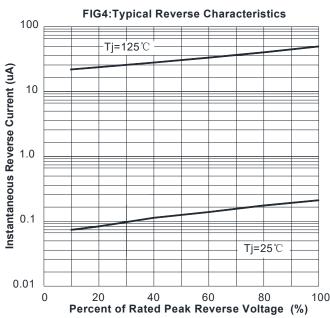
PREFERED P/N	PACKAGE CODE	UNIT WEIGHT(g)	MINIIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
KBJ1016	B1	Approximate 4.27	20	1000	2000	Tube

## **■ Characteristics**(Typical)





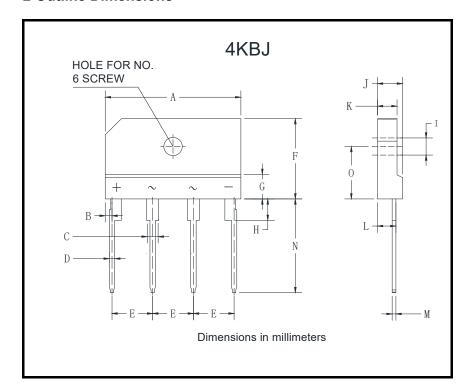








## **■ Outline Dimensions**



4KBJ					
Dim	Min	Max			
Α	24.7	25.3			
В	1.05	1.45			
С	1.7	2.1			
D	0.9	1.1			
Е	7.3	7.7			
F	14.7	15.3			
G	3.8	4.2			
Н	3.3	3.7			
I	3.1	3.4			
J	4.4	4.8			
K	3.4	3.8			
L	3.2	3.4			
М	0.6	0.8			
N	17.0	18.0			
0	9.5	10.1			



## **KBJ1016**

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